SS32~SS3200

Surface Mount Schottky Rectifiers

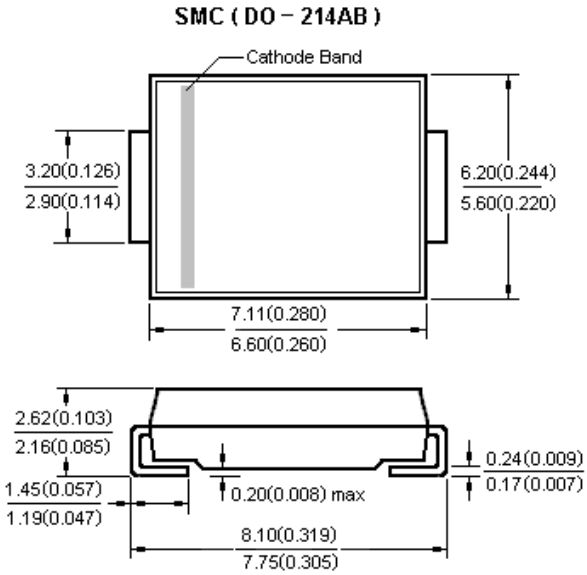
Major Ratings and Characteristics

$I_{F(AV)}$	3.0 A
V_{RRM}	20 V to 100 V
I_{FSM}	100 A
V_F	0.55 V , 0.70 V, 0.85V
T_j max.	150 °C

SMC (DO－214AB)

Features

- Low profile package
- Ideal for automated placement
- Ultrafast reverse recovery time
- Low power losses, high efficiency
- Low forward voltage drop
- High surge capability
- High temperatrue soldering：
  260℃/10 seconds at terminals
- Component in accordance to
  RoHS 2002/95/1 and WEEE 2002/96/EC



Dimentsions in millimeters and (inchs)

Mechanical Date

- Case: JEDEC DO-214ABmolded plastic body
- Terminals: Solder plated, solderable per J-STD-002B and JESD22-B102D
- Polarity: Laser band denotes cathode end

Maximum Ratings & Thermal Characteristics & Electrical Characteristics

(TA = 25 °C unless otherwise noted)

	Symbol	SS32	SS34	SS36	SS38	SS310	SS3150	SS3200	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	20	40	60	80	100	150	200	V
Maximum RMS voltage	V_{RMS}	14	28	42	56	70	105	130	V
Maximum DC blocking voltage	V_{DC}	20	40	60	80	100	150	200	V
Maximum average forward rectified current	$I_{F(AV)}$	3							A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	100							A
Maximum instantaneous forwad voltage at 3.0A	V_F	0.55		0.70	0.85		0.95		V
Maximum DC reverse current T_A = 25 ℃	I_R	0.5							mA
at Rated DC blocking voltage T_A = 120℃		5							mA
Voltage rate of change (rated VR)	dv/dt	10000							V/μs
Thermal resistance from junction to ambient	$R_{\theta JA}$	88							℃/ W
Operating junction and storage temperature range	T_J, T_{STG}	– 65 to +150							℃

Characteristic Curves (T_A=25 ℃ unless otherwise noted)

Fig.1 Forward Current Derating Curve

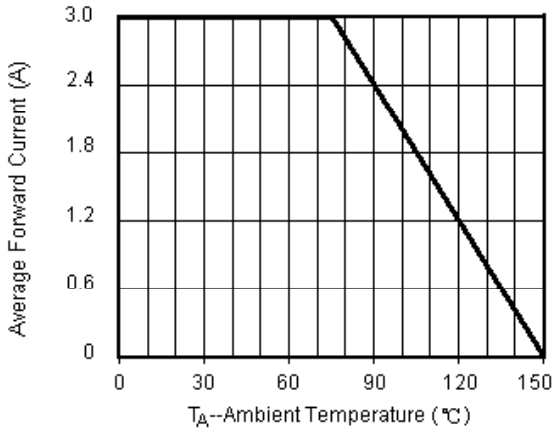


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

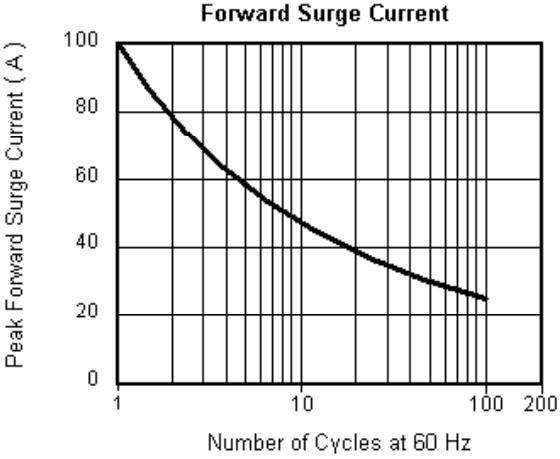


Fig.3 Typical Instantaneous Forward Characteristics

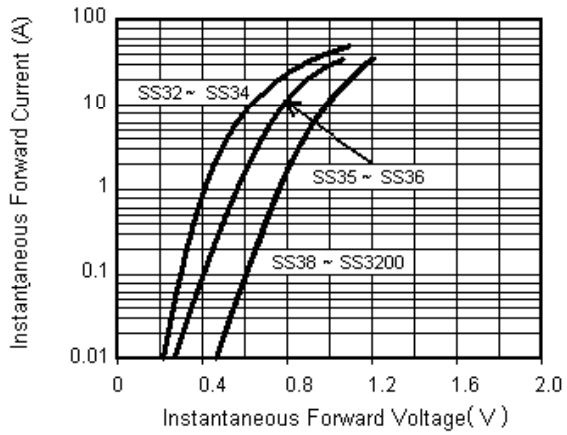


Fig.4 Typical Reverse Leakage Characteristics

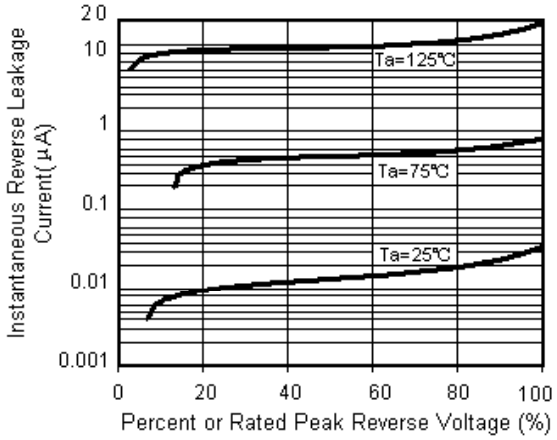


Fig.5 Typical Junction Capacitance

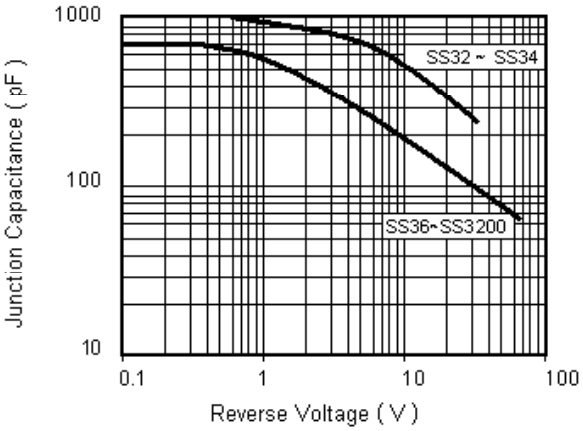


Fig.6 Transient Thermal Impedance